

GaN Amplifier 50 V, 30 W AVG 3.7 - 4.0 GHz



MACOM PURE CARBIDE

MAPC-A2506

Rev. V1

Features

- MACOM PURE CARBIDE® Amplifier Series
- Optimized for Cellular Base Station Applications
- Designed for Digital Predistortion Error Correction Systems
- Optimized for Asymmetrical Doherty Application
- High Terminal Impedances for Broadband Performance
- 50 V Operation
- 100% RF Tested
- RoHS* Compliant

Description

The MAPC-A2506 is a high power GaN on Silicon Carbide HEMT D-mode amplifier suitable for asymmetrical Doherty base station applications with 30W average power and optimized for 3.7 - 4.0 GHz modulated signal operation. The device supports pulsed, and linear operation with peak output power levels to 220 W (53.4 dBm) in an air cavity ceramic package.

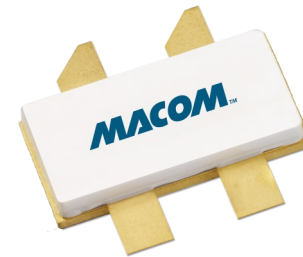
Typical Doherty Performance:

- WCDMA 3GPP TM1, 10 dB PAR @ 0.01% CCDF.
 $V_{DS} = 50\text{ V}$, $I_{DQCAR} = 150\text{ mA}$, $V_{GSPK} = -4.6\text{ V}$,
 $T_{CASE} = 25^{\circ}\text{C}$, $P_{OUT} = 44.7\text{ dBm}$

| Frequency (GHz) | GP (dB) | η_D (%) | Output PAR (dB) | ACPR (dBc) |
|-----------------|---------|--------------|-----------------|------------|
| 3.7 | 11.0 | 42.4 | 8.7 | -29.4 |
| 3.85 | 12.0 | 44.6 | 8.7 | -35.2 |
| 4.0 | 11.0 | 42.0 | 8.3 | -36.8 |

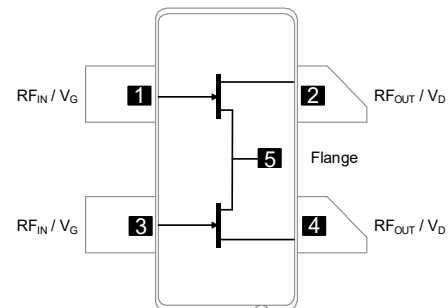
Ordering Information

| Part Number | Package |
|------------------|---------------|
| MAPC-A2506-AS000 | Bulk Quantity |
| MAPC-A2506-ASTR1 | Tape and Reel |
| MAPC-A2506-ASSB1 | Sample Board |



AC-780S-4

Functional Schematic



Pin Configuration

| Pin No. | Pin Name | Function |
|---------|------------------------------------|-----------------------------|
| 1 | RF _{IN} / V _G | RF Input / Gate (Carrier) |
| 2 | RF _{OUT} / V _D | RF Output / Drain (Carrier) |
| 3 | RF _{IN} / V _G | RF Input / Gate (Peaking) |
| 4 | RF _{OUT} / V _D | RF Output / Drain (Peaking) |
| 5 | Flange ¹ | Ground / Source |

1. The flange on the package bottom must be connected to RF, DC and thermal ground.

¹ * Restrictions on Hazardous Substances, compliant to current RoHS EU directive.

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RF Electrical Specifications: $T_C = 25^\circ\text{C}$, $V_{DS} = 50\text{ V}$, $I_{DQCAR} = 150\text{ mA}$, $V_{GSPK} = -4.6\text{ V}$

Note: Performance in MACOM Doherty Evaluation Test Fixture, 50 Ohm system.

| Parameter | Test Conditions | Symbol | Min. | Typ. | Max. | Units |
|-----------------------------------|--|---------------------------|-------------------------------|--------|------|-------|
| Small Signal Gain | Pulsed ² , 3.85 GHz | G_{SS} | - | 12.5 | - | dB |
| Saturated Output Power | Pulsed ² , 3.85 GHz | P_{SAT} | - | 54.0 | - | dBm |
| Drain Efficiency at Saturation | Pulsed ² , 3.85 GHz | η_{SAT} | - | 52.3 | - | % |
| AM/PM | Pulsed ² , 3.85 GHz | Φ | - | 6 | - | ° |
| Modulated Peak Power | WCDMA ³ , 3.85 GHz | $P_{-2.5dB}$ ⁴ | - | 54.1 | - | dBm |
| VBW Resonance Point | IMD 3rd Order Inflection Point | VBW_{RES} | - | 200 | - | MHz |
| Gain Flatness in 300 MHz | WCDMA ³ , $P_{OUT} = 44.7\text{ dBm}$ | G_F | - | 1.0 | - | dB |
| Gain Variation (-25°C to +105°C) | WCDMA ³ , 3.85 GHz, $P_{OUT} = 44.7\text{ dBm}$ | ΔG | - | 0.0174 | - | dB/°C |
| Power Variation (-25°C to +105°C) | Pulsed ² , 3.85 GHz | ΔP_{-1dB} | - | 0.0092 | - | dB/°C |
| Power Gain | WCDMA ³ , 3.85 GHz, $P_{OUT} = 44.7\text{ dBm}$ | G_P | - | 12.0 | - | dB |
| Drain Efficiency | WCDMA ³ , 3.85 GHz, $P_{OUT} = 44.7\text{ dBm}$ | η | - | 44.6 | - | % |
| Output PAR @ 0.01% CCDF | WCDMA ³ , 3.85 GHz, $P_{OUT} = 44.7\text{ dBm}$ | PAR | - | 8.7 | - | dB |
| Adjacent Channel Power Ratio | WCDMA ³ , 3.85 GHz, $P_{OUT} = 44.7\text{ dBm}$ | ACPR | - | -35 | - | dBc |
| Input Return Loss | WCDMA ³ , 3.85 GHz, $P_{OUT} = 44.7\text{ dBm}$ | IRL | - | -20 | - | dB |
| Ruggedness: Output Mismatch | All phase angles | Ψ | VSWR = 10:1, No Device Damage | | | |

RF Electrical Specifications: $T_A = 25^\circ\text{C}$, $V_{DS} = 50\text{ V}$, $I_{DQCAR} = 130\text{ mA}$, $V_{GSPK} = -5.4\text{ V}$

Note: Performance in MACOM Doherty Production Test Fixture, 50 Ω system

| Parameter | Test Conditions | Symbol | Min. | Typ. | Max. | Units |
|-------------------------|--|--------|------|------|------|-------|
| Power Gain | WCDMA ³ , 3.85 GHz, $P_{OUT} = 44.7\text{ dBm}$ | G_P | 8.1 | 9.4 | - | dB |
| Drain Efficiency | WCDMA ³ , 3.85 GHz, $P_{OUT} = 44.7\text{ dBm}$ | η | 35.6 | 39.6 | - | % |
| Output PAR @ 0.01% CCDF | WCDMA ³ , 3.85 GHz, $P_{OUT} = 44.7\text{ dBm}$ | PAR | 7.1 | 7.7 | - | dB |
| Input Return Loss | WCDMA ³ , 3.85 GHz, $P_{OUT} = 44.7\text{ dBm}$ | IRL | - | -9 | -5 | dB |

2. Pulse details: 100 μs pulse width, 10% Duty Cycle.

3. Modulated Signal: 3.84 MHz, WCDMA 3 GPP TM1 64 DPCH, 9.9 dB PAR @ 0.01% CCDF.

4. $P_{2.5dB} = P_{OUT} + 7.5\text{ dB}$ where P_{OUT} is the average output power measured using a modulated signal³ where the output PAR is compressed to 7.5 dB @ 0.01% probability CCDF.

DC Electrical Characteristics $T_A = 25^\circ\text{C}$

| Parameter | Test Conditions | Symbol | Min. | Typ. | Max. | Units |
|--|---|--------------|------|------|------|----------|
| Carrier Amplifier | | | | | | |
| Drain-Source Leakage Current (Carrier) | $V_{GS} = -8\text{ V}, V_{DS} = 130\text{ V}$ | I_{DLK} | - | - | 9.5 | mA |
| Gate-Source Leakage Current (Carrier) | $V_{GS} = -8\text{ V}, V_{DS} = 0\text{ V}$ | I_{GLK} | - | - | 9.5 | mA |
| Gate Threshold Voltage | $V_{DS} = 50\text{ V}, I_D = 9.5\text{ mA}$ | V_T | -5 | -3.1 | - | V |
| Gate Quiescent Voltage | $V_{DS} = 50\text{ V}, I_D = 130\text{ mA}$ | V_{GSQ} | -3.1 | -2.7 | -2.1 | V |
| On Resistance (Carrier) | $V_{GS} = 2\text{ V}, I_D = 67\text{ mA}$ | R_{ON} | - | 0.4 | - | Ω |
| Maximum Drain Current | $V_{DS} = 7\text{ V}$ pulsed, pulse width 300 μs | $I_{D, MAX}$ | - | 5.1 | - | A |
| Peaking Amplifier | | | | | | |
| Drain-Source Leakage Current (Peaking) | $V_{GS} = -8\text{ V}, V_{DS} = 130\text{ V}$ | I_{DLK} | - | - | 17.0 | mA |
| Gate-Source Leakage Current (Peaking) | $V_{GS} = -8\text{ V}, V_{DS} = 0\text{ V}$ | I_{GLK} | - | - | 17.0 | mA |
| Gate Threshold Voltage | $V_{DS} = 50\text{ V}, I_D = 17.0\text{ mA}$ | V_T | -5 | -3.1 | - | V |
| Gate Quiescent Voltage | $V_{DS} = 50\text{ V}, I_D = 230\text{ mA}$ | V_{GSQ} | -3.1 | -2.8 | -2.1 | V |
| On Resistance (Peaking) | $V_{GS} = 2\text{ V}, I_D = 117\text{ mA}$ | R_{ON} | - | 0.24 | - | Ω |
| Maximum Drain Current | $V_{DS} = 7\text{ V}$ pulsed, pulse width 300 μs | $I_{D, MAX}$ | - | 9.0 | - | A |

Absolute Maximum Ratings^{5,6,7,8,9}

| Parameter | Absolute Maximum |
|---|------------------|
| Drain Source Voltage, V_{DS} | 130 V |
| Gate Source Voltage, V_{GS} | -10 to 3 V |
| Gate Current (Carrier), I_G | 9.5 mA |
| Gate Current (Peaking), I_G | 17.0 mA |
| Storage Temperature Range | -65°C to +150°C |
| Case Operating Temperature Range | -40°C to +120°C |
| Channel Operating Temperature Range, T_{CH} | -40°C to +225°C |
| Absolute Maximum Channel Temperature | +250°C |

5. Exceeding any one or combination of these limits may cause permanent damage to this device.
6. MACOM does not recommend sustained operation above maximum operating conditions.
7. Operating at drain source voltage $V_{DS} < 55$ V will ensure $MTTF > 2.51 \times 10^6$ hours.
8. Operating at nominal conditions with $T_{CH} \leq 225^\circ\text{C}$ will ensure $MTTF > 2.51 \times 10^6$ hours.
9. MTTF may be estimated by the expression $MTTF \text{ (hours)} = A e^{[B + C/(T+273)]}$ where T is the channel temperature in degrees Celsius., $A = 1.93$, $B = -45.31$, and $C = 29,585$.

Thermal Characteristics¹⁰

| Parameter | Test Conditions | Symbol | Typical | Units |
|--|---|--------------------------|---------|-------|
| Thermal Resistance using Finite Element Analysis | $V_{DS} = 50$ V $T_C=85^\circ\text{C}, T_{CH} = 225^\circ\text{C}$ | $R_{\theta}(\text{FEA})$ | 2.25 | °C/W |
| Thermal Resistance using Infrared Measurement of Die Surface Temperature | $V_{DS} = 50$ V $T_C=85^\circ\text{C}, T_{CH} = 225^\circ\text{C}$ | $R_{\theta}(\text{IR})$ | 1.80 | °C/W |

10. Case temperature measured using thermocouple embedded in heat-sink. Contact local applications support team for more details on this measurement.

Handling Procedures

Please observe the following precautions to avoid damage:

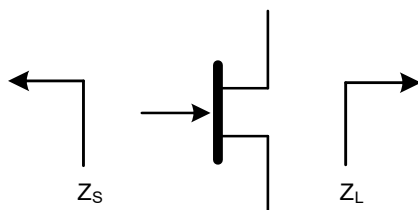
Static Sensitivity

Gallium Nitride Circuits are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these devices.

Pulsed² Load-Pull Performance: Reference Plane at Device Leads

| Carrier Amplifier: Maximum Output Power | | | | | | | |
|---|-------------------------|-------------------------------------|-----------|------------------------|----------------------|--------------------|-----------|
| V _{DS} = 50 V, I _{DQ} = 130 mA, T _C = 25°C, P2.5dB | | | | | | | |
| Frequency (GHz) | Z _{SOURCE} (Ω) | Z _{LOAD} ¹¹ (Ω) | Gain (dB) | P _{OUT} (dBm) | P _{OUT} (W) | η _D (%) | AM/PM (°) |
| 3.7 | 28.5 - j35.4 | 15.4 - j6.0 | 16.1 | 50.2 | 104.7 | 58.4 | -4.3 |
| 3.8 | 39.6 - j30.7 | 15.7 - j4.3 | 15.5 | 50.2 | 104.7 | 59.8 | -3.6 |
| 3.9 | 47.9 - j18.0 | 16.1 - j2.5 | 15.2 | 50.2 | 104.7 | 61.6 | -2.6 |
| 4.0 | 45.8 - j2.4 | 15.8 - j0.7 | 14.8 | 50.0 | 100.0 | 61.9 | -2.5 |
| Carrier Amplifier: Maximum Drain Efficiency | | | | | | | |
| V _{DS} = 50 V, I _{DQ} = 130 mA, T _C = 25°C, P2.5dB | | | | | | | |
| Frequency (GHz) | Z _{SOURCE} (Ω) | Z _{LOAD} ¹² (Ω) | Gain (dB) | P _{OUT} (dBm) | P _{OUT} (W) | η _D (%) | AM/PM (°) |
| 3.7 | 28.5 - j35.4 | 11.4 - j14.3 | 17.6 | 49.1 | 81.3 | 66.4 | -9.2 |
| 3.8 | 39.6 - j30.7 | 13.5 - j15.2 | 17.0 | 48.9 | 77.6 | 68.8 | -9.1 |
| 3.9 | 47.9 - j18.0 | 16.9 - j16.0 | 16.5 | 48.9 | 77.6 | 70.7 | -9.4 |
| 4.0 | 45.8 - j2.4 | 20.7 - j14.3 | 16.0 | 48.7 | 74.1 | 71.4 | -7.9 |
| Peaking Amplifier: Maximum Output Power | | | | | | | |
| V _{DS} = 50 V, I _{DQ} = 230 mA, T _C = 25°C, P2.5dB | | | | | | | |
| Frequency (GHz) | Z _{SOURCE} (Ω) | Z _{LOAD} ¹¹ (Ω) | Gain (dB) | P _{OUT} (dBm) | P _{OUT} (W) | η _D (%) | AM/PM (°) |
| 3.7 | 38.3 - j29.2 | 18.7 - j11.4 | 14.9 | 52.4 | 173.8 | 48.2 | -7.1 |
| 3.8 | 45.1 - j21.0 | 20.1 - j10.2 | 14.4 | 52.5 | 177.8 | 48.9 | -4.9 |
| 3.9 | 46.8 - j11.2 | 21.8 - j7.3 | 13.5 | 52.6 | 182.0 | 49.3 | -4.5 |
| 4.0 | 44.4 - j0.6 | 22.6 - j4.2 | 14.1 | 52.5 | 177.8 | 49.5 | -3.8 |
| Peaking Amplifier: Maximum Drain Efficiency | | | | | | | |
| V _{DS} = 50 V, I _{DQ} = 230 mA, T _C = 25°C, P2.5dB | | | | | | | |
| Frequency (GHz) | Z _{SOURCE} (Ω) | Z _{LOAD} ¹² (Ω) | Gain (dB) | P _{OUT} (dBm) | P _{OUT} (W) | η _D (%) | AM/PM (°) |
| 3.7 | 38.3 - j29.2 | 13.6 - j18.0 | 15.9 | 51.9 | 154.9 | 53.1 | -11.6 |
| 3.8 | 45.1 - j21.0 | 15.2 - j17.8 | 15.1 | 51.7 | 147.9 | 52.5 | -8.3 |
| 3.9 | 46.8 - j11.2 | 17.7 - j17.9 | 14.2 | 51.9 | 154.9 | 53.5 | -8.5 |
| 4.0 | 44.4 - j0.6 | 23.9 - j16.9 | 15.0 | 51.8 | 151.4 | 53.4 | -8.2 |

Impedance Reference



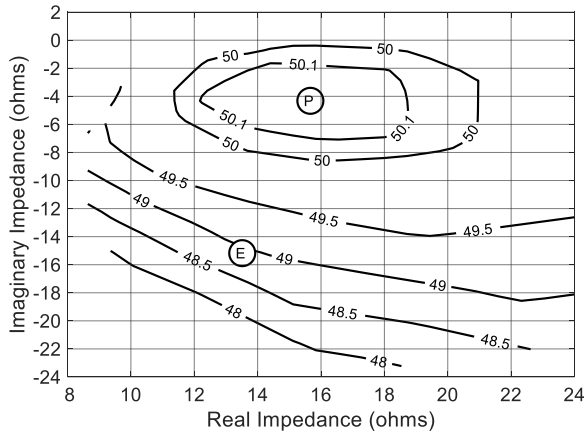
Z_{SOURCE} = Measured impedance presented to the input of the device at package reference plane.

Z_{LOAD} = Measured impedance presented to the output of the device at package reference plane.

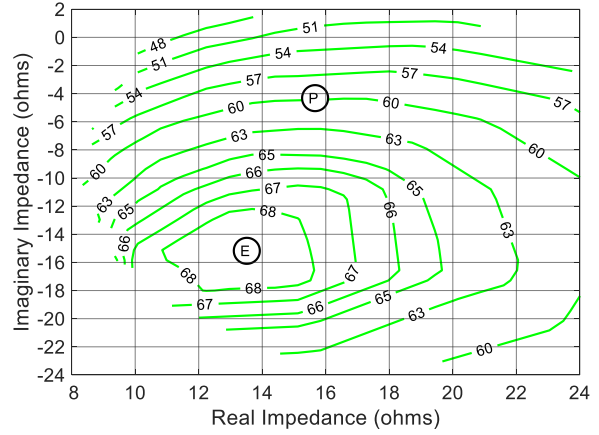
- 11. Load Impedance for optimum output power.
- 12. Load Impedance for optimum efficiency.

Pulsed² Load-Pull Performance: Carrier Amplifier 3.8 GHz

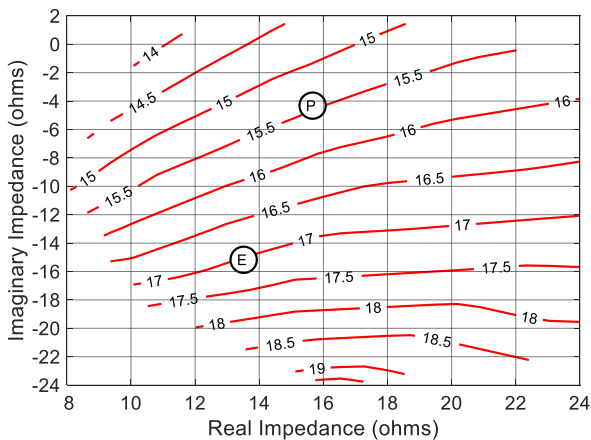
P2.5dB Loadpull Output Power Contours (dBm)



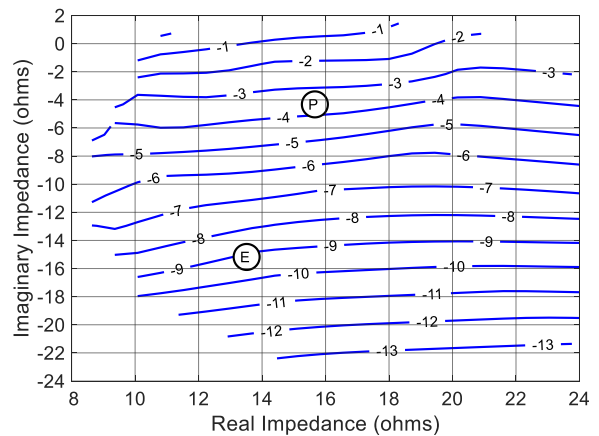
P2.5dB Loadpull Drain Efficiency Contours (%)



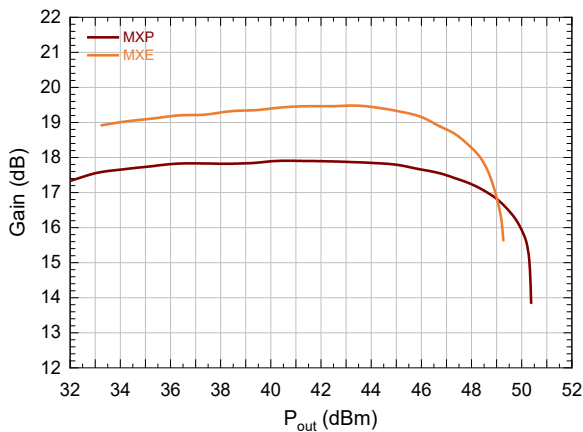
P2.5dB Loadpull Gain Contours (dB)



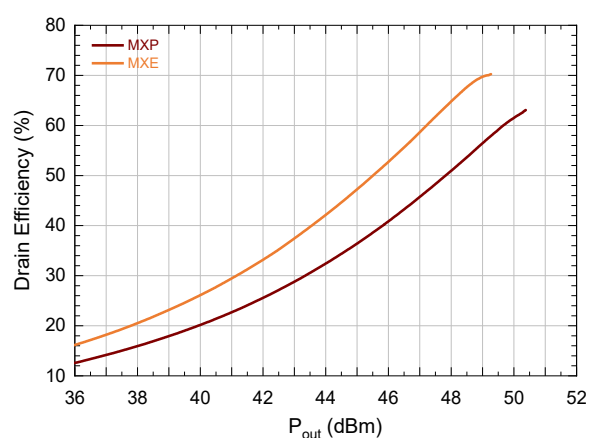
P2.5dB Loadpull AM/PM Contours (°)



Gain vs. Output Power

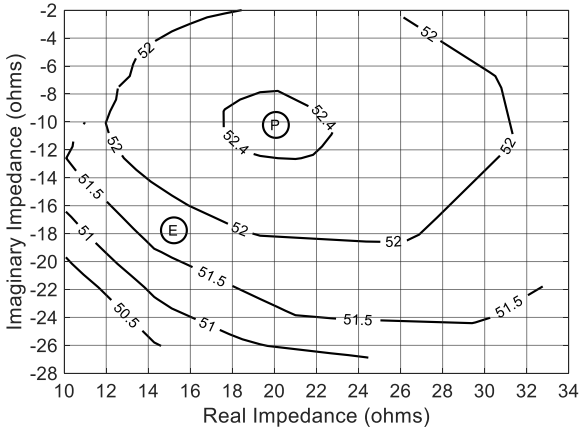


Drain Efficiency vs. Output Power

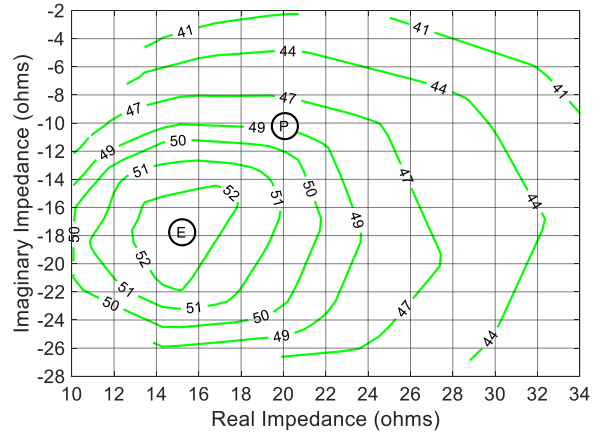


Pulsed² Load-Pull Performance: Peaking Amplifier 3.8 GHz

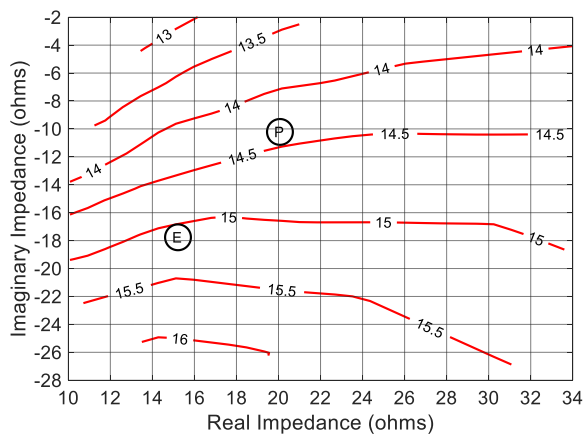
P2.5dB Loadpull Output Power Contours (dBm)



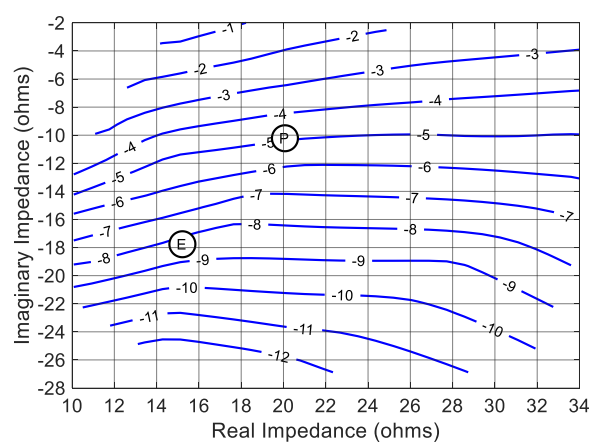
P2.5dB Loadpull Drain Efficiency Contours (%)



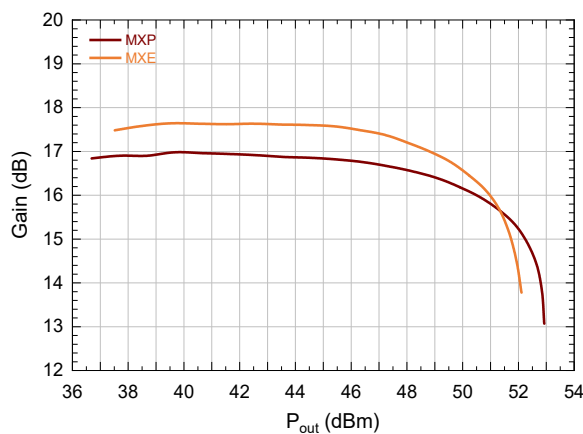
P2.5dB Loadpull Gain Contours (dB)



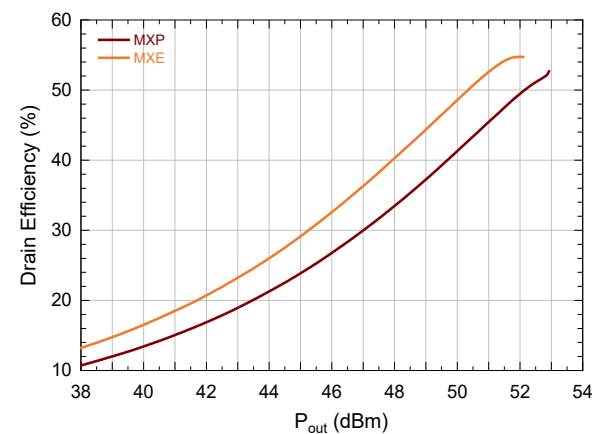
P2.5dB Loadpull AM/PM Contours (°)



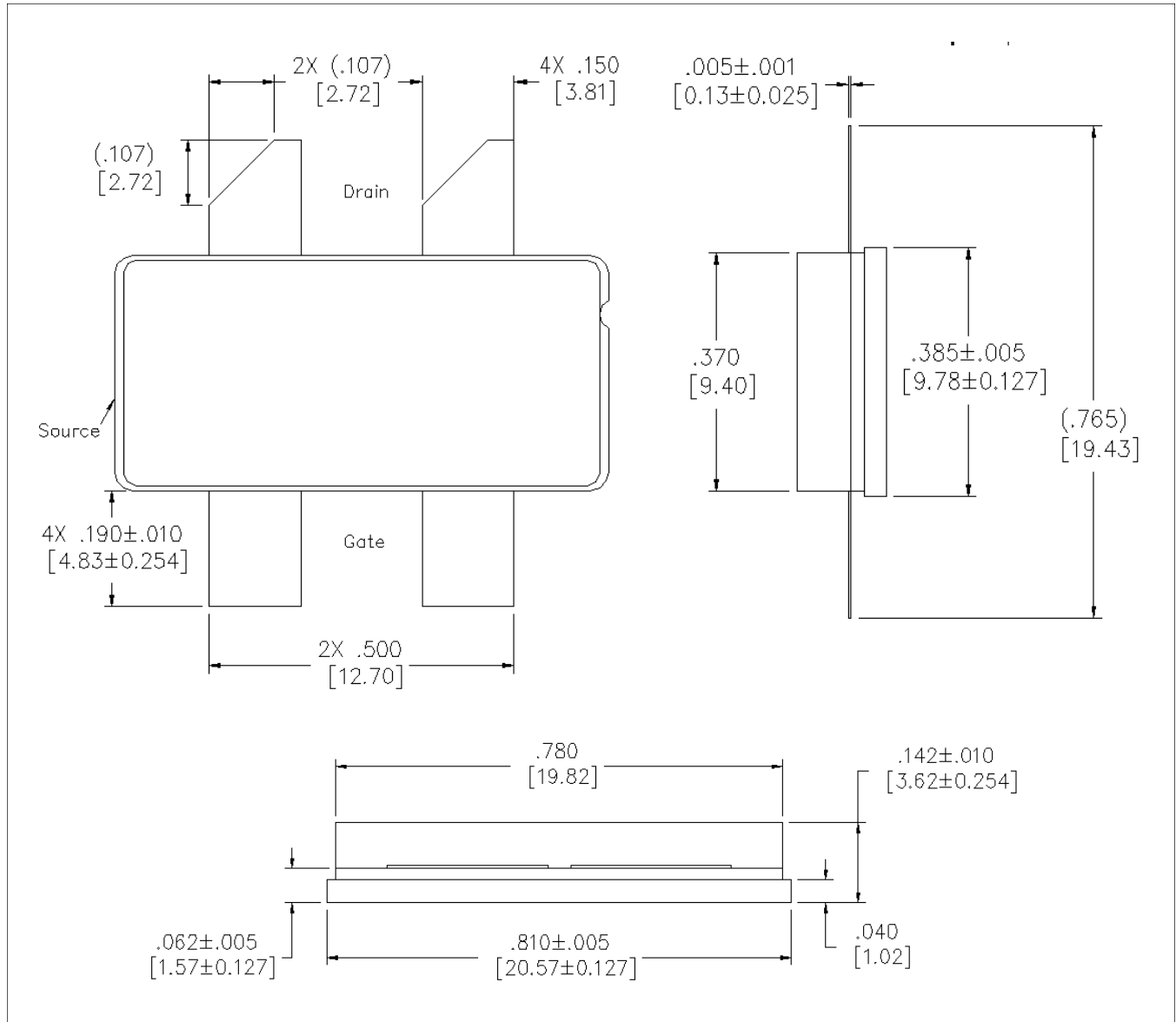
Gain vs. Output Power



Drain Efficiency vs. Output Power



Lead-Free AC-780S-4 Package Dimensions[†]



[†] Reference Application Note AN0004363 for lead-free solder reflow recommendations.
Meets JEDEC moisture sensitivity level 3 requirements.
Plating is Au.

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